

Features

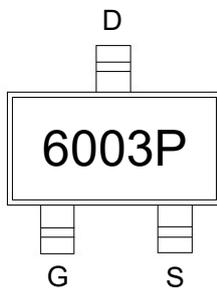
- Leading trench technology for low $R_{DS(on)}$
- Low Gate Charge
- Excellent package for good heat dissipation

Product Summary

V_{DS}	$R_{DS(ON)}$ MAX	I_D MAX
-60V	215m Ω @-10V	-3A
	280m Ω @-4.5V	

Application

- Video monitor
- Power management

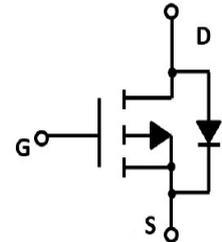


6003P: Device code

Marking and pin assignment



SOT-23-3L top view



Schematic diagram



Pb-Free



RoHS



Halogen-Free

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Symbol	Parameter	Rating	Unit
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Common Ratings (TC=25°C Unless Otherwise Noted)

V_{DS}	Drain-Source Breakdown Voltage	-60	V
V_{GS}	Gate-Source Voltage	± 20	V
T_J	Maximum Junction Temperature	150	$^{\circ}C$
T_{STG}	Storage Temperature Range	-55 to 150	$^{\circ}C$
I_S	Diode Continuous Forward Current	$T_c=25^{\circ}C$ -3	A

Mounted on Large Heat Sink

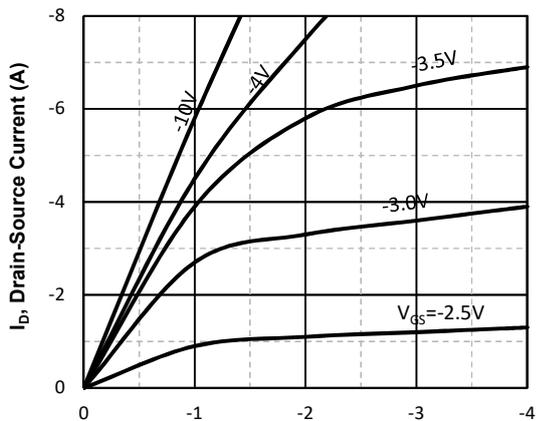
I_{DM}	Pulse Drain Current Tested	$T_c=25^{\circ}C$ -8	A
I_D	Continuous Drain Current	$T_c=25^{\circ}C$ -3	A
P_D	Maximum Power Dissipation	$T_c=25^{\circ}C$ 0.35	W
$R_{\theta JA}$	Thermal Resistance Junction-to-Ambient	357	$^{\circ}C/W$

Ordering Information (Example)

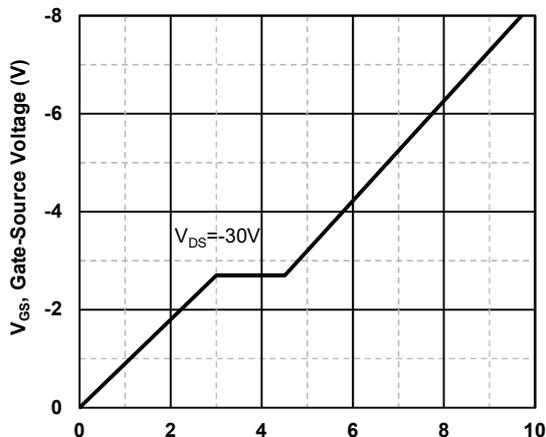
Type	Package	Marking	Minimum Package(pcs)	Inner Box Quantity(pcs)	Outer Carton Quantity(pcs)	Delivery Mode
MLSK6003P	SOT-23-3L	6003P	3,000	45,000	180,000	7"reel

Electrical Characteristics (T _J =25°C unless otherwise noted)						
Symbol	Parameter	Condition	Min	Typ	Max	Unit
Static Electrical Characteristics @ T_J = 25°C (unless otherwise stated)						
BV _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =-250μA	-60	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =-60V, V _{GS} =0V	--	--	-1	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V, V _{DS} =0V	--	--	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =-250μA	-1.2	-1.7	-2.5	V
R _{DS(on)}	Drain-Source On-State Resistance	V _{GS} =-10V, I _D =-3A	--	160	215	mΩ
		V _{GS} =-4.5V, I _D =-2A	--	200	280	mΩ
Dynamic Electrical Characteristics @ T_J = 25°C (unless otherwise stated)						
C _{ISS}	Input Capacitance	V _{DS} =-30V, V _{GS} =0V, f=1MHz	--	430	--	pF
C _{OSS}	Output Capacitance		--	33	--	pF
C _{RSS}	Reverse Transfer Capacitance		--	22	--	pF
Switching Characteristics						
Q _g	Total Gate Charge	V _{DD} =-30V, I _D =-2A, V _{GS} =-10V	--	8.5	--	nC
Q _{gs}	Gate Source Charge		--	2.1	--	nC
Q _{gd}	Gate Drain Charge		--	1.6	--	nC
t _{d(on)}	Turn-on Delay Time	V _{DD} =-30V, I _D =-1A, V _{GS} =-10V, R _G =6Ω	--	5.3	--	nS
t _r	Turn-on Rise Time		--	20	--	nS
t _{d(off)}	Turn-Off Delay Time		--	33	--	nS
t _f	Turn-Off Fall Time		--	10	--	nS
Source- Drain Diode Characteristics						
V _{SD}	Forward on voltage	T _J =25°C, I _S =-2A	--	--	-1.2	V

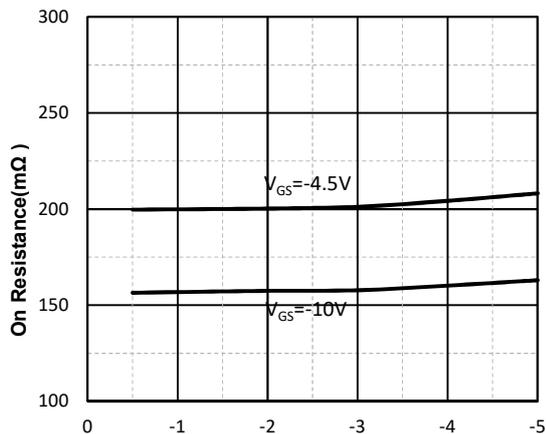
Typical Operating Characteristics



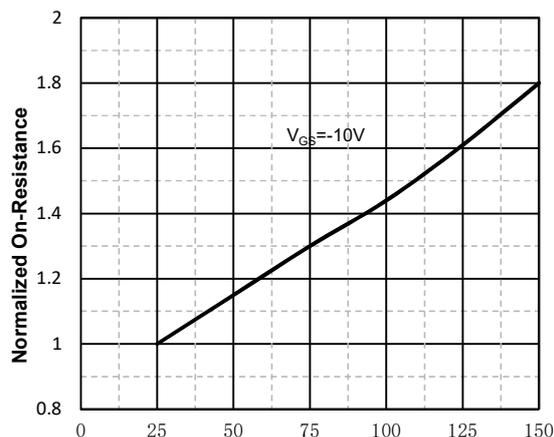
V_{DS} , Drain -Source Voltage (V)
Fig1. Typical Output Characteristics



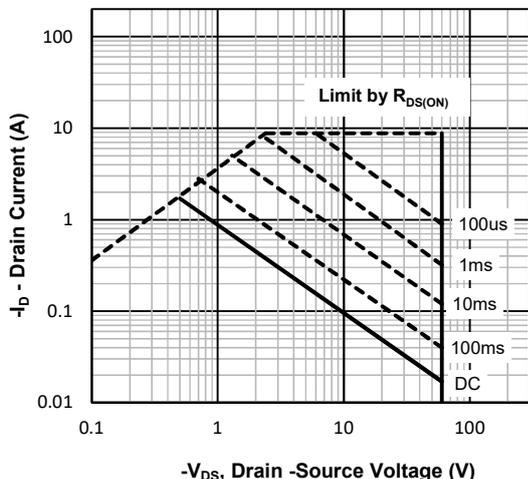
Q_g -Total Gate Charge (nC)
Fig2. Typical Gate Charge Vs. Gate-Source Voltage



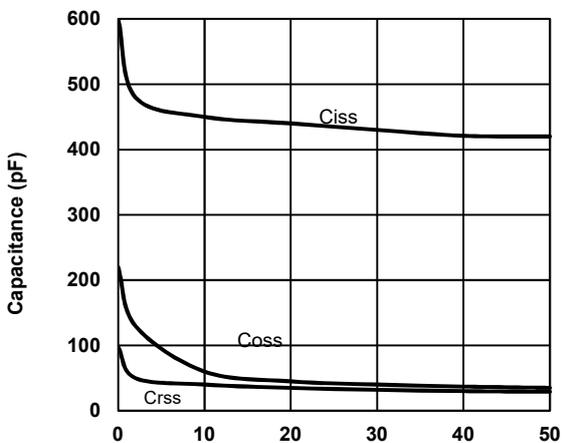
I_D , Drain-Source Current (A)
Fig3. Drain-Source on Resistance



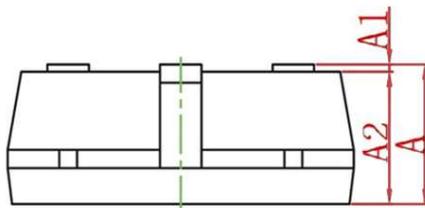
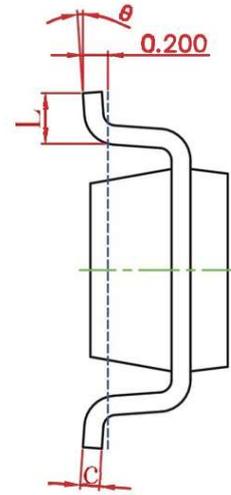
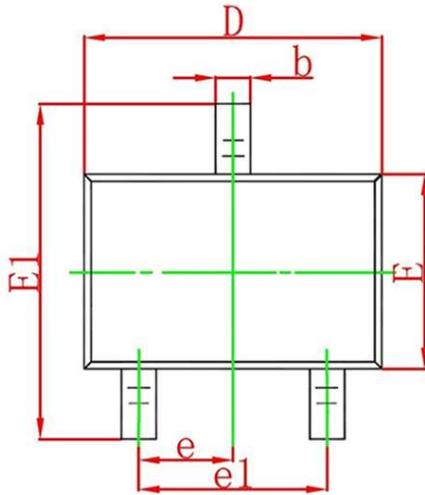
T_j - Junction Temperature ($^{\circ}C$)
Fig4. Normalized On-Resistance Vs. Temperature



$-V_{DS}$, Drain -Source Voltage (V)
Fig5. Maximum Safe Operating Area



$-V_{DS}$, Drain-Source Voltage (V)
Fig6 Typical Capacitance Vs. Drain-Source Voltage

SOT-23-3L Package information


Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
A	1.050	1.250	0.042	0.050
A1	0.000	0.100	0.000	0.004
A2	1.050	1.150	0.042	0.046
b	0.300	0.500	0.012	0.020
c	0.100	0.200	0.004	0.008
D	2.820	3.020	0.112	0.120
E	1.500	1.700	0.060	0.068
E1	2.650	2.950	0.106	0.118
e	0.950TYP		0.037TYP	
e1	1.800	2.000	0.071	0.079
L	0.300	0.600	0.012	0.024
θ	0°	8°	0°	8°